



# RoHS TEST REPORT

For

LED STEP LIGHT

**Model No.:** VT-1162, VT-1152, VT-1143, VT-1142, VT-8035, VT-1172, VT-1182, VT-1166,  
VT-1141, VT-1151, VT-1161, VT-1171

**Applicant :** V-TAC EXPORTS LIMITED  
ROOM NO.301, KAM ON BUILDING 176A QUEENS ROAD CENTRAL,  
CENTRAL, HONGKONG

**Manufacturer :** V-TAC EXPORTS LIMITED  
ROOM NO.301, KAM ON BUILDING 176A QUEENS ROAD CENTRAL,  
CENTRAL, HONGKONG

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**Report Number :** D00.06.0445R-R2

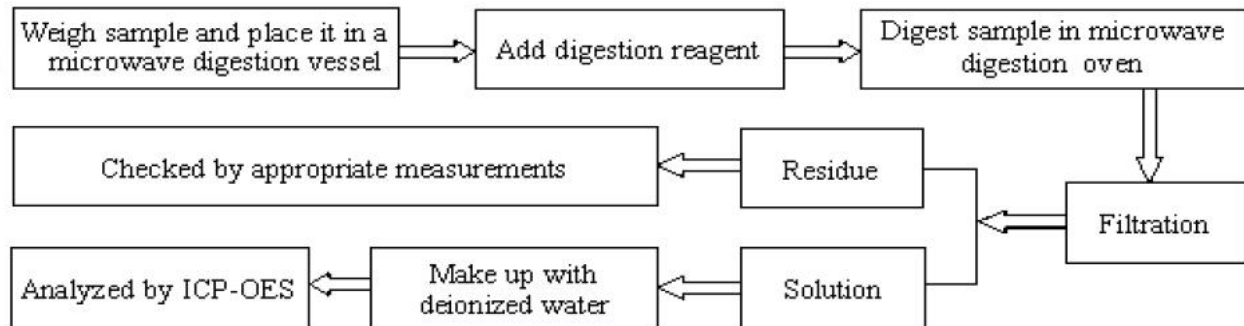
**Issued Date :** April 19, 2019

**Date of Report :** April 19, 2019

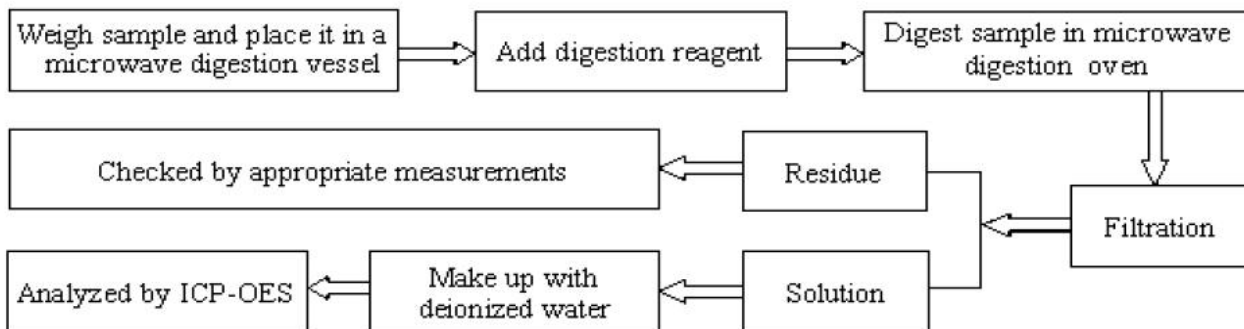
**Note:**

1. The test data and result is based on the tested sample only.
2. Please verify information in the report on GST web: [www.gstslab.com](http://www.gstslab.com) through report number.
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4. This report is based on report D00.06.0445R-R1 which issued on January 02, 2018.

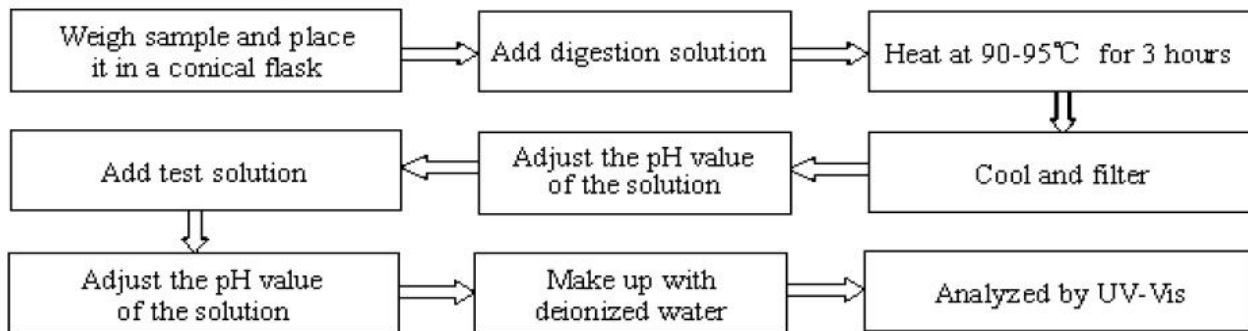
### 1. Lead(Pb), Cadmium(Cd)



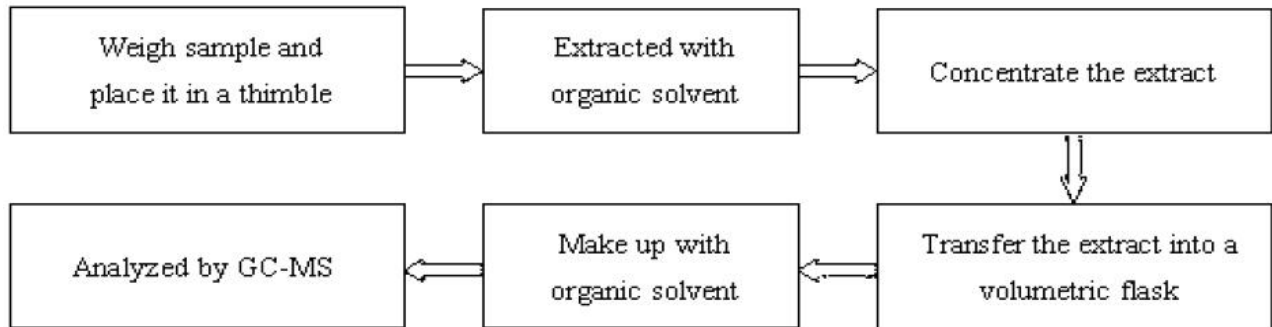
### 2. Mercury(Hg)



### 3. Hexavalent Chromium (Cr(VI))



**4. Polybrominated Biphenyls (PBBs), Polybrominated Diphenyl Ethers(PBDEs) ,  
HBCDD, DBP, DEHP, BBP**



**Method Detection Limit (MDL) in wet chemical test**

Test Items	Pb	Cd	Hg	PBBs & PBDEs
Unit	mg/kg	mg/kg	mg/kg	mg/kg
MDL	2	2	2	2

<b>Result</b>	:	<b>Pass</b>
<b>Conclusion</b>	:	An independent evaluation on the above-mentioned product(s) has been conducted pursuant to 2011/65/EU and (EN)2015/863 of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment, and concluded that the equipment under evaluation met the legislative requirements of this directive.



### Test Data Summary

SAMPLE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusion (P/F)
1	Enclosure	Cd	P	/	<100	N.A.
		Cr	P	/	<1000	N.A.
		Hg	P	/	<1000	N.A.
		Pb	P	/	<1000	N.A.
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
2	Transparent cover	Cd	P	/	<100	N.A.
		Cr	P	/	<1000	N.A.
		Hg	P	/	<1000	N.A.
		Pb	P	/	<1000	N.A.
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
3	Screws	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	/	<1000	N.A.
		PBDEs	D	/	<1000	N.A.
		HBCDD	D	/	<1000	N.A.
		DEHP	D	/	<1000	N.A.
		DBP	D	/	<1000	N.A.
		BBP	D	/	<1000	N.A.
4	Nut	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	/	<1000	N.A.
		PBDEs	D	/	<1000	N.A.
		HBCDD	D	/	<1000	N.A.
		DEHP	D	/	<1000	N.A.
		DBP	D	/	<1000	N.A.
		BBP	D	/	<1000	N.A.

SAMP LE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusio n (P/F)
5	LED	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
6	LED PCB	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
7	Internal wire	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
8	PCB of driver	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P

SAMPLE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusion (P/F)
9	Resistors	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
10	Capacitor	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
11	Rectifier	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
12	Inductance	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		

SAMP LE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusio n (P/F)
13	Glue	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		
14	Soldering tin	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	/	<1000	N.A.
		PBDEs	D	/	<1000	N.A.
		HBCDD	D	/	<1000	N.A.
		DEHP	D	/	<1000	N.A.
		DBP	D	/	<1000	N.A.
BBP	D	/	<1000	N.A.		
15	Diode	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		
16	Terminal blocks	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		

SAMP LE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusio n (P/F)
17	Triode	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		
18	Heat-shrinkable tube	Cd	P	/	<100	N.A.
		Cr	P	/	<1000	N.A.
		Hg	P	/	<1000	N.A.
		Pb	P	/	<1000	N.A.
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		
19	Gasket	Cd	P	/	<100	N.A.
		Cr	P	/	<1000	N.A.
		Hg	P	/	<1000	N.A.
		Pb	P	/	<1000	N.A.
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		

Note:

(1) N.D. = Not detected (<MDL)

(2) ppm = mg/kg

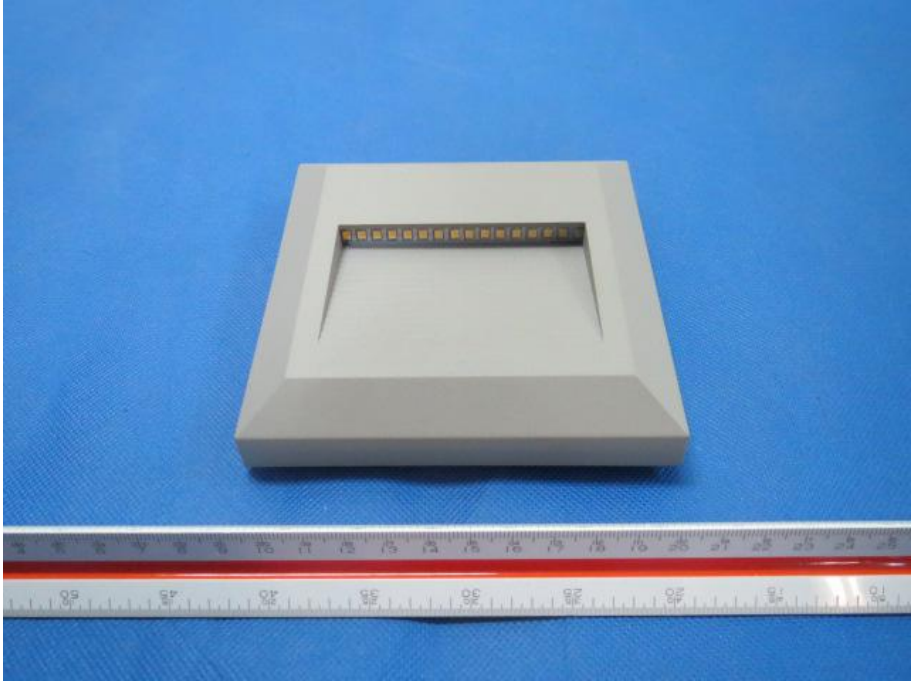
(3) N.A. = Not Analyzed

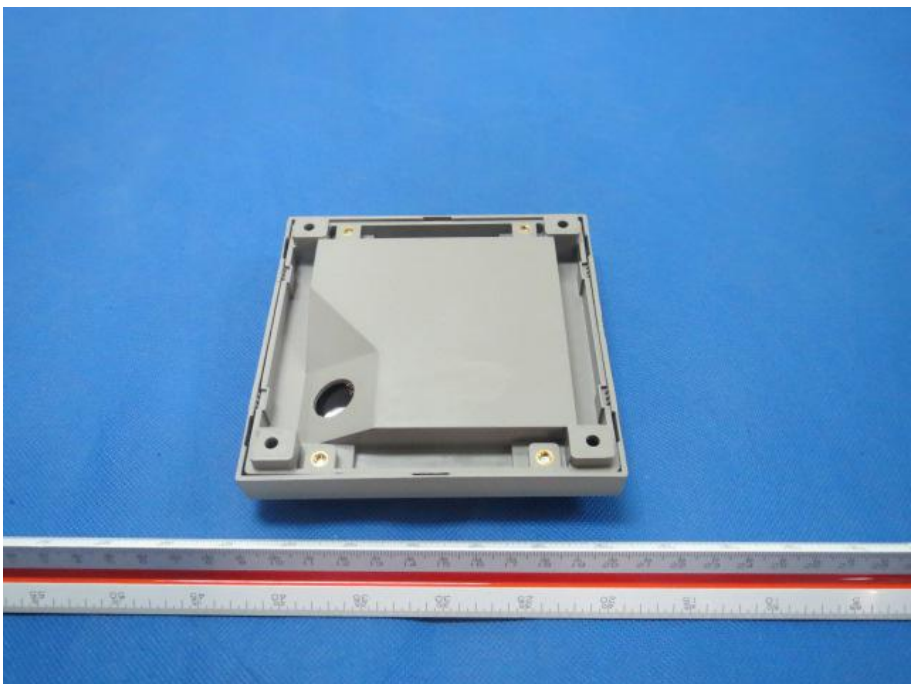
(4) Negative = the concentration of Hexavalent Chromium extracted from 50cm<sup>2</sup> sample is less than the detection limit.

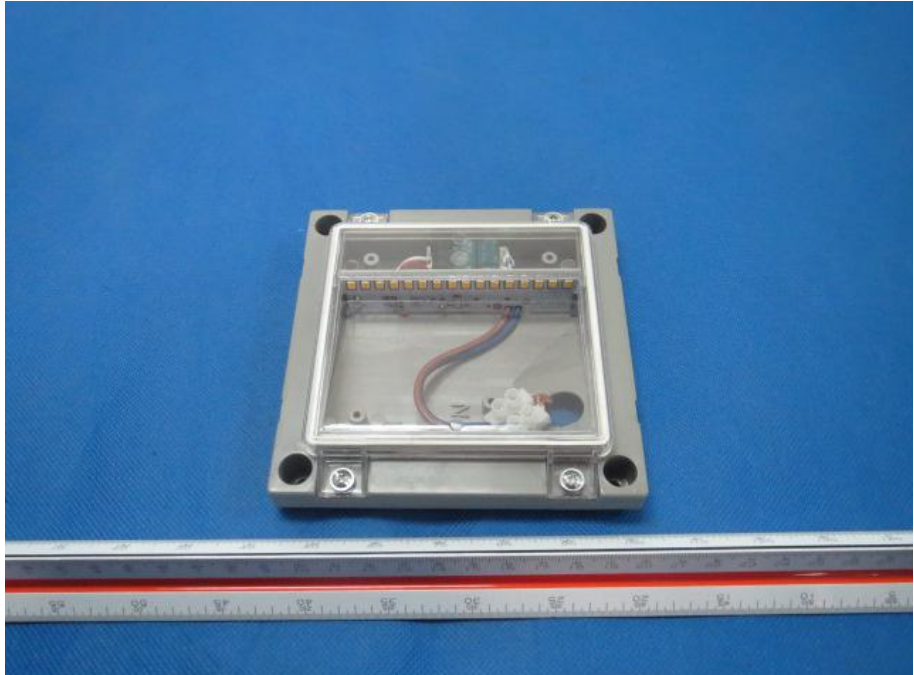


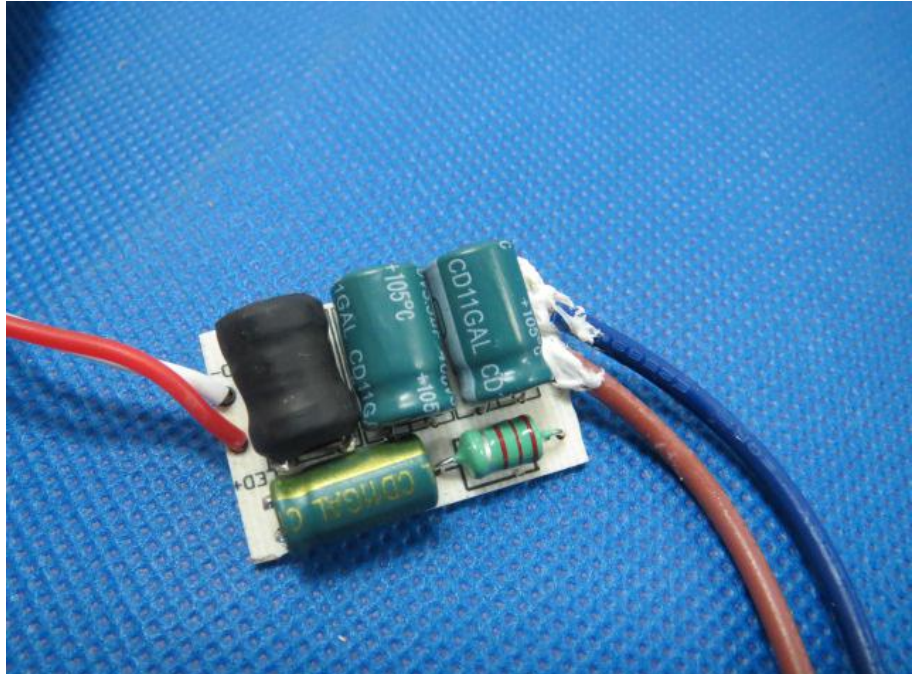
**Appendix 1**

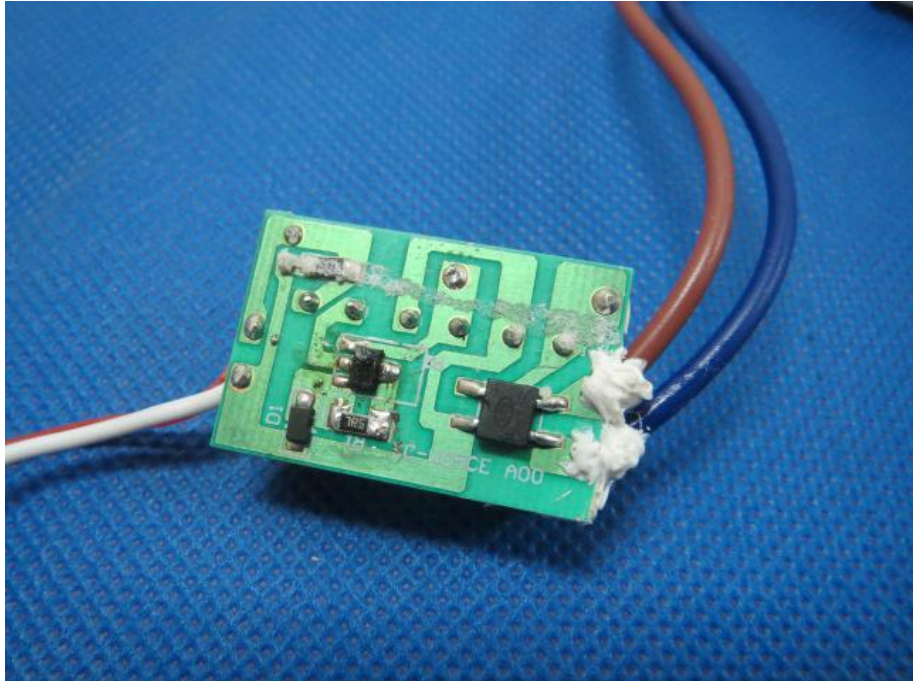
Photo documentation

<p>Photo 1</p> <p>View:</p> <p><input checked="" type="checkbox"/> Front</p> <p><input type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input type="checkbox"/> Internal</p>	 <p>A photograph showing the front view of a grey, rectangular component. The component has a recessed area in the center. A ruler is placed below the component for scale, showing it is approximately 10 cm wide. The background is a blue textured surface.</p>
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<p>Photo 2</p> <p>View:</p> <p><input type="checkbox"/> Front</p> <p><input checked="" type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input type="checkbox"/> Internal</p>	 <p>A photograph showing the rear view of the same grey rectangular component. The rear view reveals internal components, including a circular hole and several small gold-colored contacts. A ruler is placed below the component for scale, showing it is approximately 10 cm wide. The background is a blue textured surface.</p>
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<p>Photo 3</p> <p>View:</p> <p><input type="checkbox"/> Front</p> <p><input checked="" type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input type="checkbox"/> Internal</p>	 <p>A photograph showing the rear view of a rectangular electronic device. The device is silver-colored with a clear window revealing internal components, including a red and blue cable and a white component. A ruler is placed below the device for scale. The background is blue.</p>
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<p>Photo 4</p> <p>View:</p> <p><input type="checkbox"/> Front</p> <p><input type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input checked="" type="checkbox"/> Internal</p>	 <p>A photograph showing the internal view of a circuit board. The board is populated with several components: a black component, a green electrolytic capacitor labeled '105°C', a green electrolytic capacitor labeled 'CD11GAL CD', and a green electrolytic capacitor labeled 'CD11GAL CD'. There are also red and blue wires connected to the board. The background is blue.</p>
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<p>Photo 5</p> <p>View:</p> <p><input type="checkbox"/> Front</p> <p><input type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input checked="" type="checkbox"/> Internal</p>	 <p>The photograph shows the internal view of a green printed circuit board (PCB). The board is populated with several electronic components, including a central integrated circuit (IC) and various passive components like resistors and capacitors. The board is connected to three wires: a red wire, a blue wire, and a white wire. The wires are secured to the board with white adhesive. The PCB is resting on a blue textured surface. The text 'DI' and 'CE A00' is visible on the board.</p>
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--END--